

54F/74F273

Octal D Flip-Flop

General Description

The 'F273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset (MR) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the MR input. The device is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

Features

- Ideal buffer for MOS microprocessor or memory
- Eight edge-triggered D flip-flops
- Buffered common clock
- Buffered, asynchronous Master Reset
- See 'F377 for clock enable version
- See 'F373 for transparent latch version
- See 'F374 for TRI-STATE® version
- Guaranteed 4000V minimum ESD protection

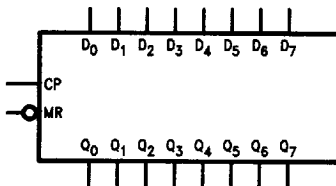
Ordering Code: See Section 11

Commercial	Military	Package Number	Package Description
74F273PC		N20A	20-Lead (0.300" Wide) Molded Dual-In-Line
	54F273DM (Note 2)	J20A	20-Lead Ceramic Dual-In-Line
74F273SC (Note 1)		M20B	20-Lead (0.300" Wide) Molded Small Outline, JEDEC
74F273SJ (Note 1)		M20D	20-Lead (0.300" Wide) Molded Small Outline, EIAJ
	54F273FM (Note 2)	W20A	20-Lead Cerpack
	54F273LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

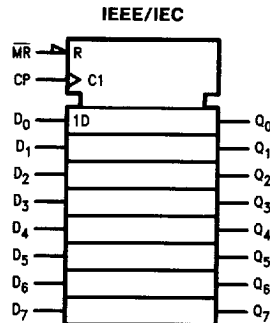
Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbols



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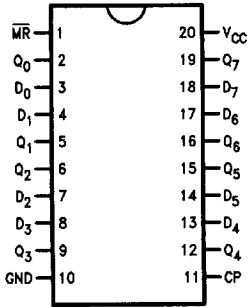


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Connection Diagrams

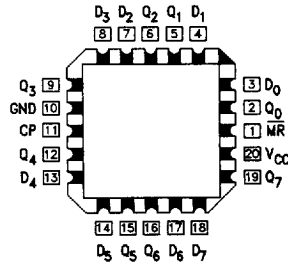
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Pin Assignment for
DIP, SOIC and Flatpak



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Pin Assignment
for LCC



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Unit Loading/Fan Out: See Section 2 for U.L. definitions

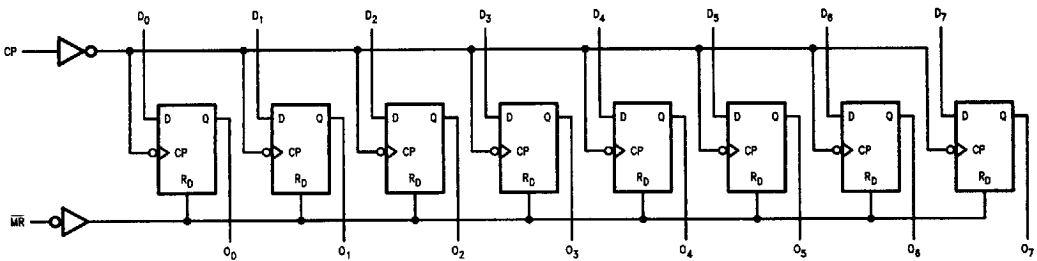
Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input I _H /I _L Output I _{OH} /I _{OL}
D ₀ -D ₇	Data Inputs	1.0/1.0	20 μA/-0.6 mA
MR	Master Reset (Active LOW)	1.0/1.0	20 μA/-0.6 mA
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 μA/-0.6 mA
Q ₀ -Q ₇	Data Outputs	50/33.3	-1 mA/20 mA

Mode Select-Function Table

Operating Mode	Inputs			Output
	MR	CP	D _n	Q _n
Reset (Clear)	L	X	X	L
Load '1'	H	↗	h	H
Load '0'	H	↗	l	L

H = HIGH Voltage Level steady state
h = HIGH Voltage Level one setup time prior to the LOW-to-HIGH clock transition
L = LOW Voltage Level steady state
l = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock transition
X = Immaterial
↗ = LOW-to-HIGH clock transition

Logic Diagram



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Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	-0.5V to V _{CC}
TRI-STATE Output	-0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)
ESD Last Passing Voltage (min)	4000V


Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IH} = -18 mA
V _{OH}	Output HIGH Voltage	Mil 10% V _{CC} 5% V _{CC}	2.5 2.5 2.7		V	Min	I _{OH} = -1 mA
V _{OL}	Output LOW Voltage	Mil 10% V _{CC} 5% V _{CC}		0.5 0.5 0.5	V	Min	I _{OL} = 20 mA
I _{IH}	Input HIGH Current	54F 74F		20.0 5.0	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F		100 7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current	54F 74F		250 50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	74F	4.75		V	0.0	I _{ID} = 1.9 μA All other pins grounded
I _{OD}	Output Leakage Circuit Current	74F		3.75	μA	0.0	V _{IOD} = 150 mV All other pins grounded
I _{IL}	Input LOW Current			-0.6	mA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current		-60	-150	mA	Max	V _{OUT} = 0V
I _{CCH} I _{CCL}	Power Supply Current			44 56	mA	Max	CP =  D _n = \overline{MR} = HIGH

AC Electrical Characteristics: See Section 2 for Waveforms and Load Configurations

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Symbol	Parameter	74F			54F		74F		Units	Fig. No.
		T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A , V _{CC} = Mil C _L = 50 pF		T _A , V _{CC} = Com C _L = 50 pF			
		Min	Typ	Max	Min	Max	Min	Max		
f _{max}	Maximum Clock Frequency	160			95		130		MHz	2-1
t _{PLH} t _{PHL}	Propagation Delay Clock to Output	3.0		7.0	2.5	9.5	2.5	7.5	ns	2-4
t _{PLH} t _{PHL}	Propagation Delay MR to Output	4.5		9.5	3.0	11.0	4.0	10.0	ns	2-4

AC Operating Requirements: See Section 2 for Waveforms

Symbol	Parameter	74F		54F		74F		Units	Fig. No.
		T _A = +25°C V _{CC} = +5.0V		T _A , V _{CC} = Mil		T _A , V _{CC} = Com			
		Min	Max	Min	Max	Min	Max		
t _s (H) t _s (L)	Setup Time, HIGH or LOW Data to CP	3.0		3.5		3.0		ns	2-6
t _h (H) t _h (L)	Hold Time, HIGH or LOW Data to CP	3.5		4.0		3.5			
t _h (H) t _h (L)	Hold Time, HIGH or LOW Data to CP	0.5		1.0		0.5		ns	2-4
t _w (L)	MR Pulse Width, LOW	1.0		1.0		1.0			
t _w (H) t _w (L)	CP Pulse Width HIGH or LOW	6.0		4.0		6.0		ns	2-4
t _w (H) t _w (L)	CP Pulse Width HIGH or LOW	6.0		5.0		6.0			
t _{rec}	Recovery Time, MR to CP	6.0		5.0		6.0		ns	2-4